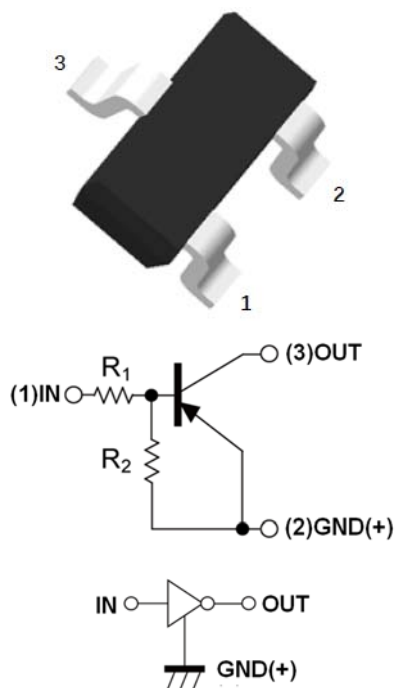


PNP Digital Transistors (Built-in Resistors)



Features

- Moisture sensitivity level 1
- Halogen free and RoHS compliant
- Surface mount package ideally suited for automatic insertion

Application

- Signal amplification
- Switching circuit

Mechanical data

- **Package:** SOT-523
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102

■ Maximum Ratings (T_a=25°C Unless otherwise specified)

Item	Symbol	Unit	Conditions	Value
Device marking code				14
Supply voltage	V _{CC}	V		-50
Input voltage	V _{IN}	V		-40 to 10
Output current	I _O	mA		-100
Power dissipation	P _D	mW		100
Junction temperature	T _J	°C		-55 to +150
Storage temperature	T _{STG}	°C		-55 to +150



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■ Electrical Characteristics (T_a=25°C Unless otherwise specified)

Item	Symbol	Unit	Conditions	Min	Typ	Max
Input voltage	V _{I(off)}	V	V _{CC} =-5V, I _O =-100uA	-0.5		
	V _{I(on)}	V	V _O =-0.3V, I _O =-10mA			-3
Output voltage	V _{O(on)}	V	I _O / I _I = -10mA/-0.5 mA			-0.3
Input current	I _I	mA	V _I =-5V			-0.88
Output current	I _{O(off)}	uA	V _{CC} =-50V, V _I =0			-0.5
DC current gain	G _I		V _O =-5V, I _O =-5mA	30		
Input resistance	R ₁	kΩ		7	10	13
Resistance ratio	R ₂ /R ₁			0.8	1	1.2
Transition frequency	f _T	MHz	V _O =-10V, I _O =-5mA, f=100MHz		250	

■ Thermal Characteristics

Parameter	Symbol	Unit	Value
Thermal resistance, junction-to-ambient	R _{θJ-A} ⁽¹⁾	°C/W	833
Thermal resistance, junction-to-case	R _{θJ-C} ⁽¹⁾	°C/W	666

Note:

(1) Thermal resistance from junction to ambient and from junction to case mounted on P.C.B. with 25.4mm*25.4mm copper pad areas

■ Ordering Information

Preferred P/N	Packing code	Unit weight(g)	Minimum package(pcs)	Inner box quantity(pcs)	Outer carton quantity(pcs)	Delivery mode
DTA114EE	F2	Approximate 0.0013	8000	80000	320000	7" reel



■Characteristics(Typical)

Fig 1: DC Current Gain Characteristics

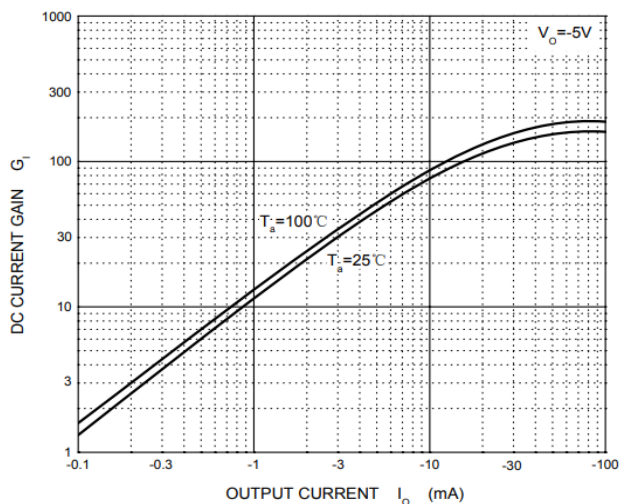


Fig 2: Input Voltage (On) Characteristics

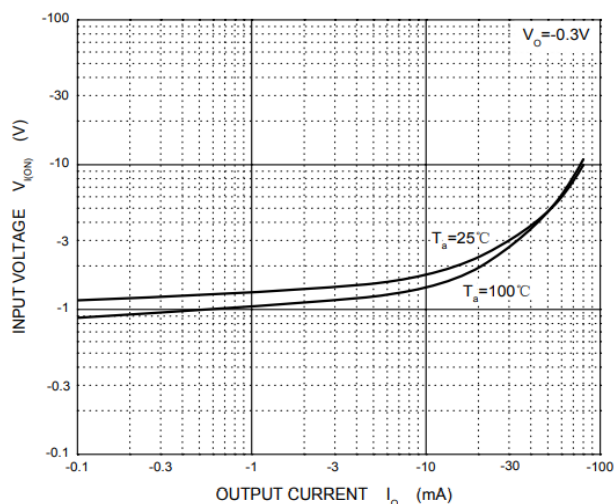


Fig 3: Input Voltage (Off) Characteristics

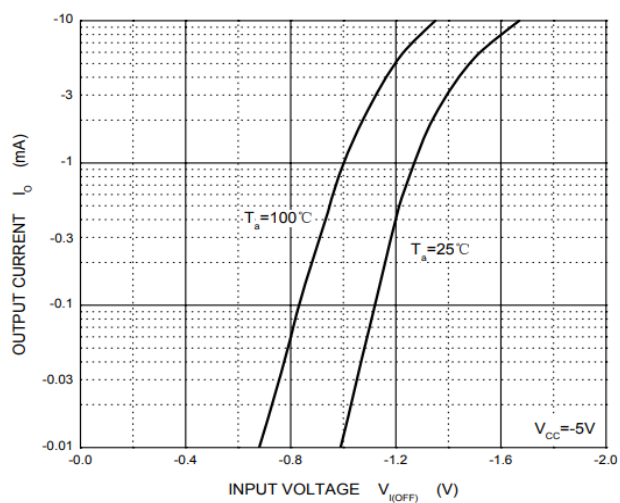


Fig 4: Output Voltage Characteristics

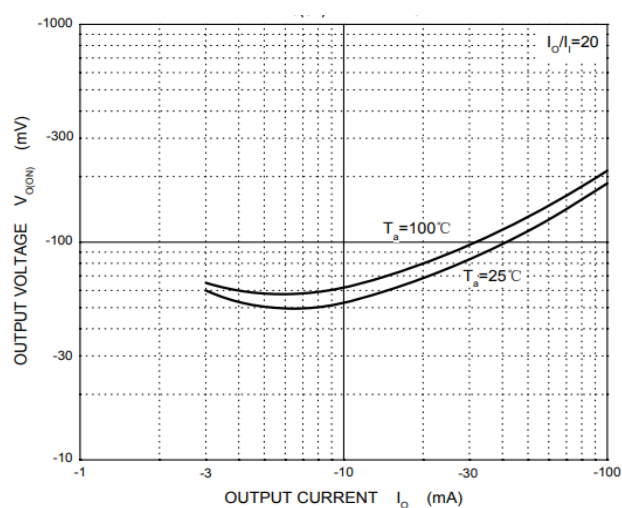
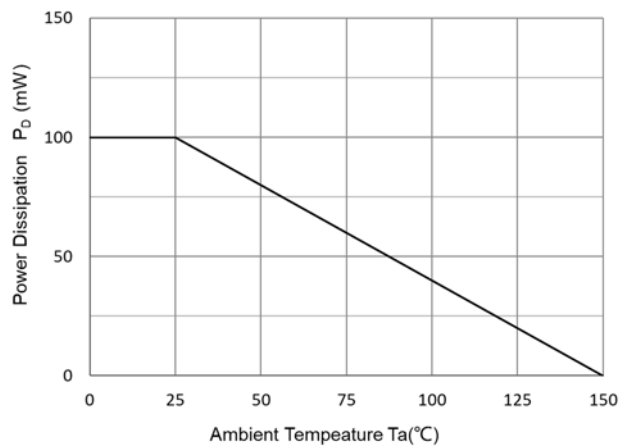


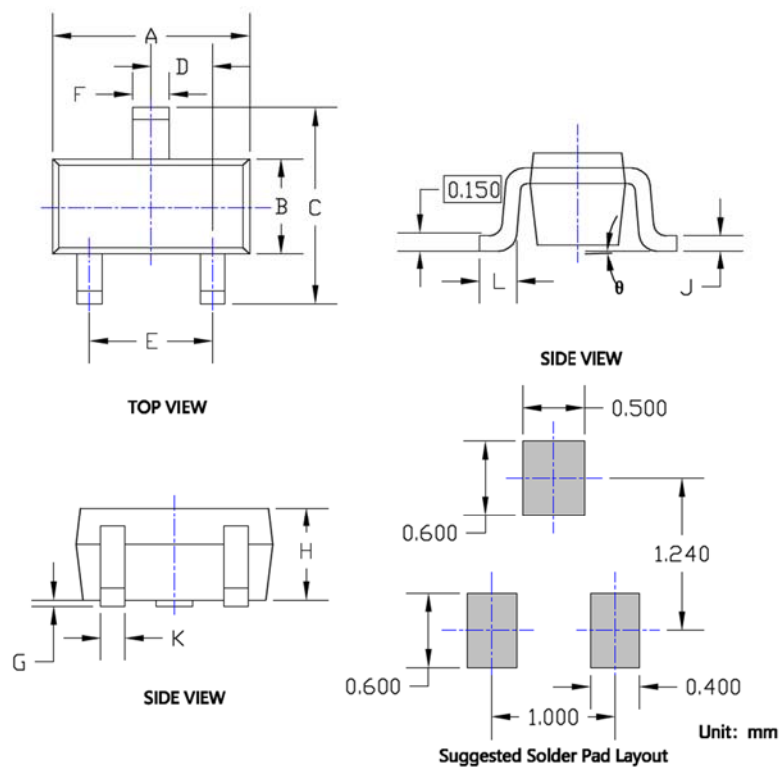
Fig 5: P_D - T_a Curve





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■ Outline Dimensions



SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.059	0.067	1.500	1.700
B	0.030	0.033	0.750	0.850
C	0.057	0.069	1.450	1.750
D	0.020TYP		0.500TYP	
E	0.035	0.043	0.900	1.100
F	0.010	0.018	0.250	0.450
G	0.000	0.004	0.000	0.100
H	0.024	0.031	0.600	0.800
J	0.004	0.008	0.100	0.200
K	0.006	0.014	0.150	0.350
L	0.010	0.018	0.260	0.460
θ	0°	8°	0°	8°

NOTE:

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
2. TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
3. THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.

Note:

1. All dimensions are in millimeters (mm) unless otherwise specified.
[所有尺寸均以毫米为单位, 除非另有说明]
2. General tolerances: $\pm 0.10\text{mm}$ unless otherwise specified.
[通用公差为 $\pm 0.10\text{mm}$, 除非另有说明]
3. Dimensions and tolerances per ASME Y14.5M-2018.
[尺寸和公差遵循 ASME Y14.5M-2018 标准]
4. All dimensions shown are exclusive of burrs and gate residues. Burrs and gate vestiges shall not exceed 0.15 mm in maximum.
[所有尺寸均不包括毛刺和浇口残留。毛刺与浇口残留的尺寸最大不得超过 0.15mm]
5. Dimension b does not include dambar protrusion of max 0.100 mm per side.
[尺寸b不包括单边最大0.100 mm的中筋凸出部分]
6. Dimensions A and B are the overall extreme outer dimensions of the mold compound. These dimensions exclude mold flash, lead flash, protrusions and burrs but include the maximum allowable mold mismatch.
[A和B是塑封体的外部极限尺寸, 不包括包封溢料、内引线溢料、凸出部分以及胶体毛刺, 但是包含了包封错位的最大尺寸]
7. Formed leads shall be planar with respect to one another within a maximum of 0.076 mm relative to the seating plane.
[成型的管脚应为同一平面, 共面性最大为0.1mm]
8. ★It is the key size.
[★ 标记为关键尺寸]



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